



P0404FC3.3C*
thru
P0404FC36C*

BIDIRECTIONAL FLIP CHIP

APPLICATIONS

- ✓ Cellular Phones
- ✓ MCM Boards
- ✓ Wireless Communication Circuits
- ✓ IR LEDs
- ✓ SMART Cards & PCMCIA Cards

IEC COMPATIBILITY (EN61000-4)

- ✓ 61000-4-2 (ESD): Air - 15kV, Contact - 8kV
- ✓ 61000-4-4 (EFT): 40A - 5/50ns

FEATURES

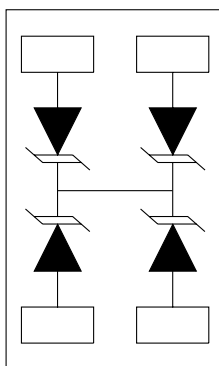
- ✓ ESD Protection > 25 kilovolts
- ✓ Available in Multiple Voltage Types Ranging From 3.3V to 36V
- ✓ 250 Watts Peak Pulse Power Dissipation per Line (8/20 μ s)
- ✓ Monolithic Structure

MECHANICAL CHARACTERISTICS

- ✓ Standard EIA Chip Size: 0404
- ✓ Weight 0.73 milligrams (Approximate)
- ✓ Flammability Rating UL 94V-0
- ✓ 8mm Plastic & Paper Tape and Reel Per EIA Standard 481
- ✓ Device Marking On Reel
- ✓ Top Contacts: Solder Bump 0.004" in Height (Nominal)



CIRCUIT DIAGRAM



P0404FC3.3C*

thru

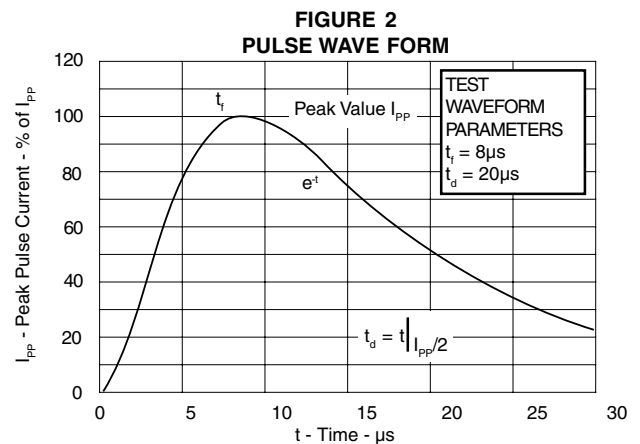
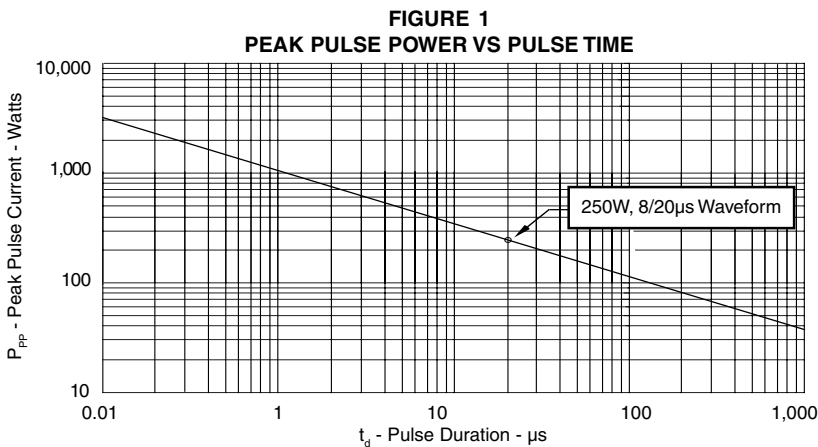
P0404FC36C*

DEVICE CHARACTERISTICS

MAXIMUM RATINGS @ 25°C Unless Otherwise Specified			
PARAMETER	SYMBOL	VALUE	UNITS
Peak Pulse Power ($t_p = 8/20\mu s$) - See Figure 1	P_{PP}	250	Watts
Operating Temperature	T_J	-55°C to 150°C	°C
Storage Temperature	T_{STG}	-55°C to 150°C	°C

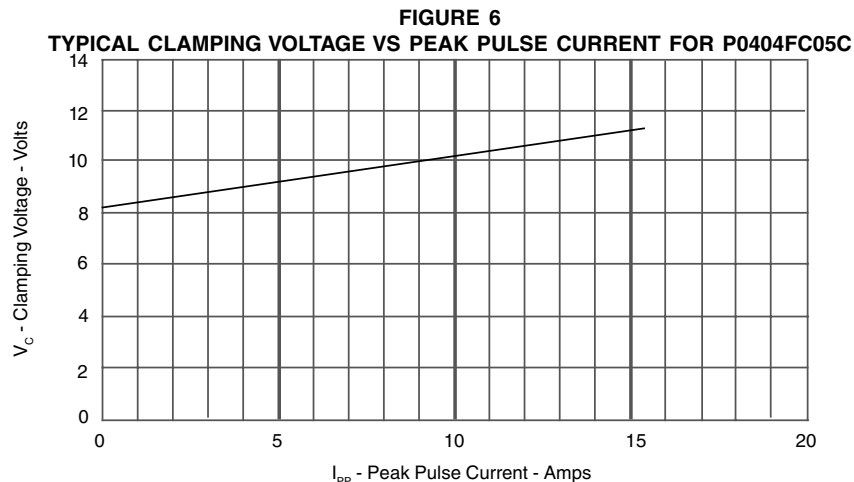
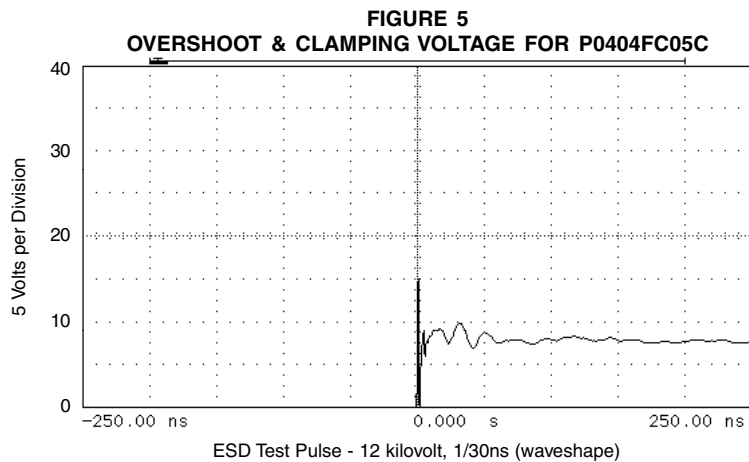
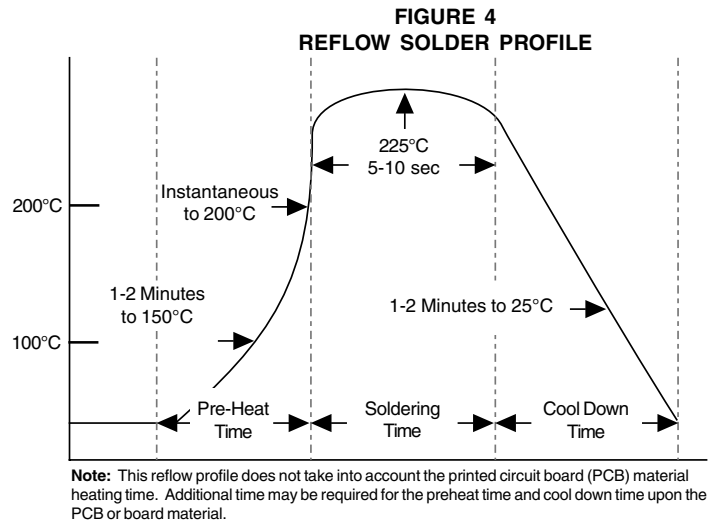
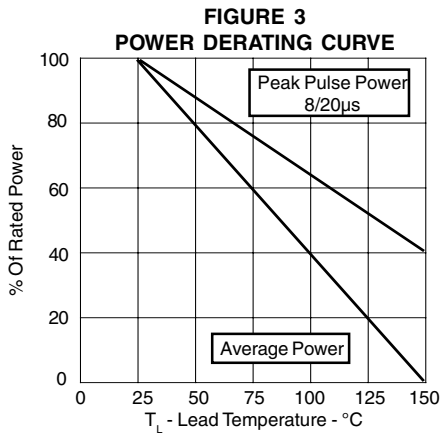
ELECTRICAL CHARACTERISTICS PER LINE @ 25°C Unless Otherwise Specified						
PART NUMBER (See Note 1)	RATED STAND-OFF VOLTAGE V_{WM} VOLTS	MINIMUM BREAKDOWN VOLTAGE @ 1mA $V_{(BR)}$ VOLTS	MAXIMUM CLAMPING VOLTAGE (See Fig. 2) @ $I_p = 1A$ V_C VOLTS	MAXIMUM CLAMPING VOLTAGE (See Fig. 2) @ 8/20 μs V_C @ I_{PP}	MAXIMUM LEAKAGE CURRENT @ V_{WM} I_D μA	TYPICAL CAPACITANCE 0V @ 1 MHz C pF
P0404FC3.3C	3.3	4.0	7.0	12.5V @ 20A	75	150
P0404FC05C	5.0	6.0	9.8	14.7V @ 17A	10	100
P0404FC08C	8.0	8.5	13.4	19.2V @ 13A	10	75
P0404FC12C	12.0	13.3	19.0	29.7V @ 9.0A	1	50
P0404FC15C	15.0	16.7	24.0	35.7V @ 7.0A	1	40
P0404FC24C	24.0	26.7	43.0	55.0V @ 5.0A	1	30
P0404FC36C	36.0	40.0	64.0	84.0V @ 3.0A	1	25

Note 1: All devices are bidirectional. Electrical characteristics apply in both directions.



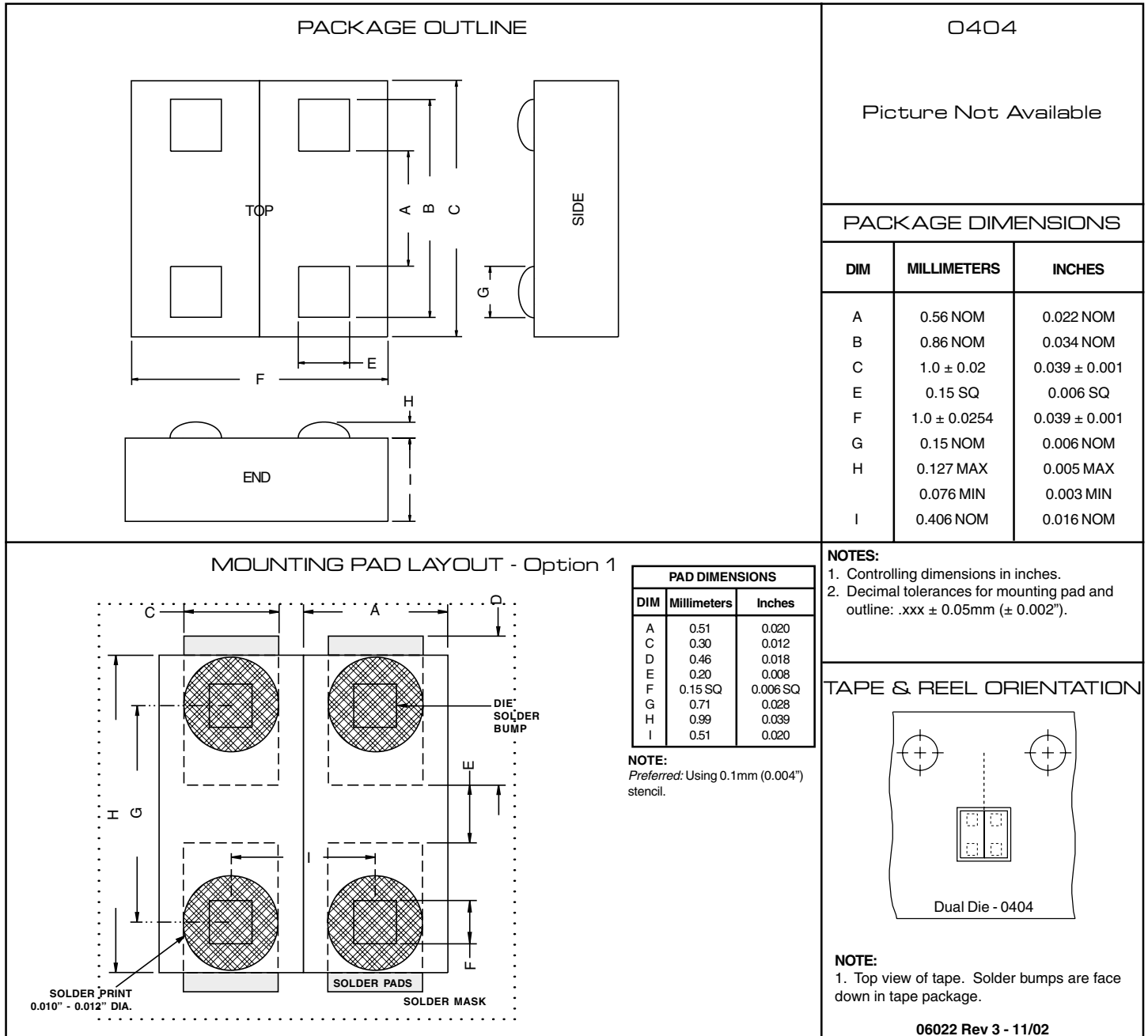
P0404FC3.3C* thru P0404FC36C*

GRAPHS



P0404FC3.3C* thru P0404FC36C*

PACKAGE OUTLINE & DIMENSIONS



TAPE & REEL ORIENTATION

Dual Die - 0404

NOTE:
1. Top view of tape. Solder bumps are face down in tape package.

06022 Rev 3 - 11/02

TAPE & REEL ORDERING INFORMATION:

Surface mount product is taped and reeled in accordance with EIA-481.

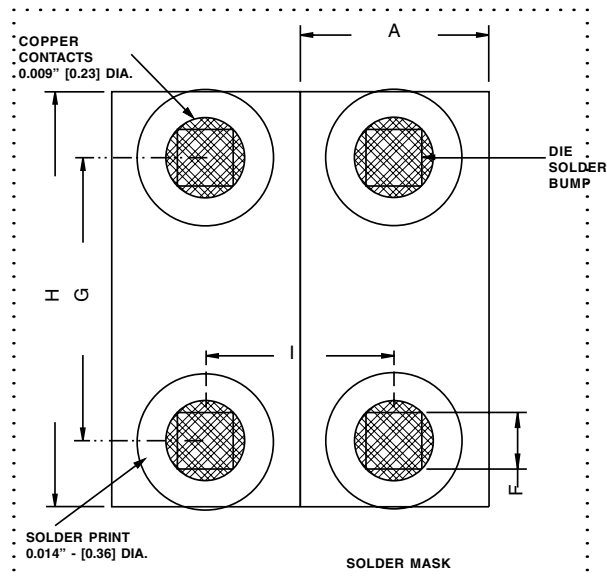
Plastic Tape: 7 Inch Reels - 5,000 pieces per reel. Ordering Suffix: -T75-1 (i.e., P0404FC05C-T75-1).

Paper Tape: 7 Inch Reels - 10,000 pieces per reel. Ordering Suffix: -T710-2 (i.e., P0404FC05C-T710-2).

PO404FC3.3C* thru PO404FC36C*

PACKAGE OUTLINE & DIMENSIONS

MOUNTING PAD LAYOUT - Option 2



PAD DIMENSIONS

DIM	Millimeters	Inches
A	0.51	0.020
F	0.15 SQ	0.006 SQ
G	0.71	0.028
H	0.99	0.039
I	0.51	0.020

NOTES:

1. Controlling dimensions in inches.
2. Decimal tolerances for mounting pad and outline:
.xxx ± 0.05mm (± 0.002").
3. Preferred: Using 0.1mm (0.004") stencil.

06022 Rev 3 - 11/02

COPYRIGHT © ProTek Devices 2003

SPECIFICATIONS: ProTek reserves the right to change the electrical and or mechanical characteristics described herein without notice (except JEDEC). DESIGN CHANGES: ProTek reserves the right to discontinue product lines without notice, and that the final judgement concerning selection and specifications is the buyer's and that in furnishing engineering and technical assistance, ProTek assumes no responsibility with respect to the selection or specifications of such products.

ProTek Devices

2929 South Fair Lane, Tempe, AZ 85282

Tel: 602-431-8101 Fax: 602-431-2288

E-Mail: sales@protekdevices.com

Web Site: www.protekdevices.com